1. General Description

The WR0612 series low-power, low-dropout, CMOS linear voltage regulators operate from a 2.0V to 5.5V input voltage and deliver up to 600mA output current. A low ground current and a 10nA logic-controlled shutdown mode make this part attractive for battery power systems. The WR0612 series feature low dropout voltage to prolong battery life in portable electronics. Systems requiring a quiet voltage source, such as RF applications, will benefit from low output noise and high PSRR of the WR0612 series.

The WR0612 has the fold-back maximum output current limit with respect to the output voltage and thermal shutdown protection.

The WR0612 has auto-discharge function to quickly discharge V_{OUT} when the device is disabled.

The WR0612 is available in Green DFN2 × 2-6 packages. It operates over an ambient temperature range of -40℃ to +85℃.

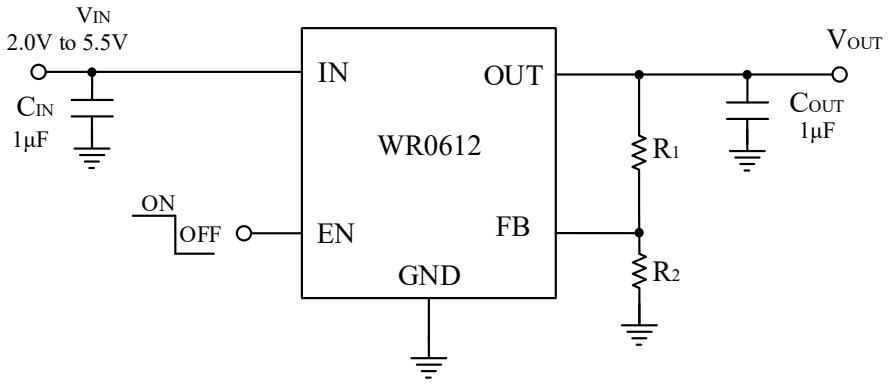
2. Features

- Low Dropout Voltage
- 25μA Low Ground Current
- 10nA Logic-Controlled Shutdown
- 2.0V to 5.5V Input Voltage Range
- Adjustable Output from 0.8V to 5.0V
- 600mA Output Current
- Quick Start-Up Time
- High Output Voltage Accuracy
- Short Auto-Discharge Function
- Thermal Overload Protection
- Built-In Fold Back Protection Circuit

3. Applications

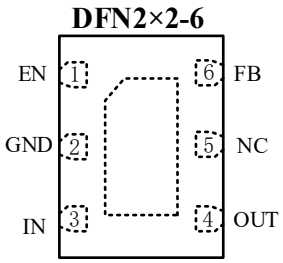
- Cellular Telephones
- Cordless Telephones
- PCMCIA Cards
- Modems
- Hand-Held Instruments
- Palmtop Computers
- Electronic Planners
- Portable/Battery-Powered Equipment

4. Typical Application Circuit



5. Pin Configuration

(Top View)



6. Pin Description

PIN NUMBER	PIN NAME	I/O	PIN FUNCTION
1	EN	I	Enable input. Active High. EN is pulled down by a resistor of about 6.8MΩ.
2	GND	-	Common ground.
3	IN	I	Input voltage supply. Bypass with a typical 1μF capacitor to GND. Place the input capacitor as close to the IN and GND pins of the device as possible.
4	OUT	O	Regulated output voltage. A low equivalent series resistance (ESR) capacitor, typically 1μF, is required from OUT to ground for stability. Place the output capacitor as close to the OUT and GND pins of the device as possible. An internal 50Ω (typical) pull-down resistor can quickly discharge V_{OUT} when it's disabled.
5	NC	-	NC
6	FB	-	Feedback Pin

7. Absolute Maximum Ratings

Over operating free-air temperature range (unless otherwise noted)[1]

SYMBOL	PARAMETER	RATING	UNIT
V_{IN}	IN to GND	-0.3 to 6	V
V_{EN}, V_{FB}	EN, FB Input Voltage Range	-0.3 to V_{IN}	V
V_{OUT}	OUT to GND	-0.3V to (V_{IN} + 0.3V)	V
P_D	Power Dissipation $P_{D(MAX)}$@T_A = 25℃	606[2]	mW
		800[3]	
$R_{\theta JA}$	Thermal resistance	165[2]	°C/W
		125[3]	
T_J	Junction Temperature	150	°C
T_{SDR}	Storage Temperature Range	-65 to +150	°C
T_{STG}	Lead Temperature (Soldering, 10 sec)	260	°C
ESD	HBM	±4000	V

NOTE 1: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

NOTE2: Measured on 2cm x 2cm 2-layer FR4 PCB board, 1 oz copper, no via holes on GND copper.

NOTE3: Measured on 2cm x 2cm 4-layer FR4 PCB board, 1 oz copper, no via holes on GND copper.

8. Recommended Operating Conditions

SYMBOL	PARAMETER	MIN	MAX	UNIT
V_{IN}	Input Voltage	2.0	5.5	V
T_A	Operating Ambient Temperature	-40	85	°C

9. Electrical Characteristics

(V_{IN} = $V_{OUT\ (NOMINAL)}$ + 0.5V or 2.0V, whichever is greater, T_A=25℃, unless otherwise noted)

SYMBOL	PARAMETER	TEST CONDITIONS		MIN	TYP.	MAX	UNIT
V_{IN}	Input Voltage			2.0		5.5	V
V_{OUT}	Output Voltage Accuracy	I_{OUT} = 0.1mA		-2		+2	%
V_{FB}	Feedback Voltage	I_{OUT}=1mA		0.784	0.8	0.816	V
I_{OUT}	Maximum Output Current [1]			600			mA
I_{LIM}	Current Limit				900		mA
I_Q	Quiescent Current	No Load, V_{EN} = V_{IN}			25	30	μA
I_{SHORT}	Short Current Limit	V_{OUT} = 0V			400		mA
V_{DO}	Dropout Voltage[2]	I_{OUT}= 600mA	V_{OUT} = 0.8V		1200	1400	mV
			V_{OUT} = 0.9V		1100	1300	mV
			1.0V ≤ V_{OUT} < 1.1V		950	1050	mV
			1.1V ≤ V_{OUT} < 1.2V		800	950	mV
			1.2V ≤ V_{OUT} < 1.5V		650	850	mV
			1.5V ≤ V_{OUT} < 1.8V		580	750	mV
			1.8V ≤ V_{OUT} < 2.1V		500	650	mV
			2.1V ≤ V_{OUT} < 2.5V		450	570	mV
			2.5V ≤ V_{OUT} < 3.0V		400	530	mV
			3.0V ≤ V_{OUT} < 3.6V		380	490	mV
			3.6V ≤ V_{OUT} ≤ 5.0V		330	420	mV
$\frac{\Delta V_{OUT}}{\Delta V_{IN} \times V_{OUT}}$	Line Regulation	V_{IN} = 2V or (V_{OUT} +0.5V) to 5.5V,I_{OUT} = 1mA	1.8V ≤ V_{OUT} ≤ 3.3V		0.01	0.06	%/V
			V_{OUT}<1.8V, V_{OUT} > 3.3V		0.01	0.1	
ΔV_{OUT}	Load Regulation	I_{OUT} = 0.1mA to 600mA			12		mV

SYMBOL	PARAMETER	TEST CONDITIONS		MIN	TYP.	MAX	UNIT
PSRR	Power Supply Rejection Ratio	I_{OUT} = 30mA, C_{OUT} = 1μF, V_{IN} = V_{OUT} + 1V, ΔV_{RIPPLE} = 0.5V_{P-P}	f = 217Hz		75		dB
			f = 1KHz		70		
V_{NO}	Output noise voltage	f = 10Hz to 100kHz, C_{OUT} = 1μF, V_{OUT} = 1.8V	I_{OUT} = 0mA		100		μV_{RMS}
			I_{OUT} = 30mA		200		
V_{ENH}	EN Input Threshold	V_{IN}=5.5V, I_{OUT}=1mA		1.5			V
V_{ENL}		V_{IN}=5.5V, I_{OUT}=1mA				0.4	
I_{ENH}	EN Input Bias Current	V_{EN} = 5.5V			0.8	2	μA
I_{ENL}		V_{EN} = 0V			0.01	1	
I_{SHDN}	Shutdown Supply Current	V_{EN} = 0V			0.01	1	μA
t_{STR}	Start-up Time [3]	C_{OUT} = 1μF, No Load			30		μs
R_{DIS}	Output Discharge resistance	V_{IN} = 4.0V, V_{EN} = 0V			50		Ω
T_{SD}	Thermal Shutdown Temperature				165		°C
ΔT_{SD}	Thermal Shutdown Hysteresis				20		°C

NOTE1. Maximum output current is affected by the PCB layout, size of metal trace, the thermal conduction path between metal layers, ambient temperature and the other environment factors of system. Attention should be paid to the dropout voltage when V_{IN} < V_{OUT} + V_{DROP}.

NOTE2. The dropout voltage is defined as (V_{IN}-V_{OUT}) when V_{OUT} is $V_{OUT(NOM)}$*98% at T_A=25℃ and maybe various with respect to load and temperature.

NOTE3. Time needed for V_{OUT} to reach 90% of final value.

10. Typical Performance Characteristics

(T_A=25°C, V_{IN}=V_{OUT}+0.5V, C_{IN}=C_{OUT}=1μF, unless otherwise noted)

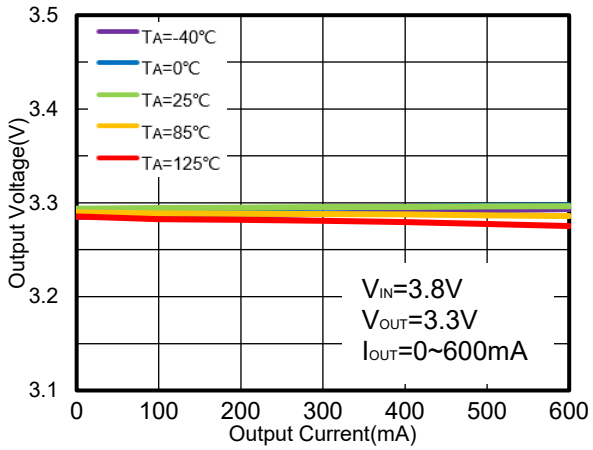


Figure 1. WR0612-ADFF6R
Output Voltage vs. Output Current

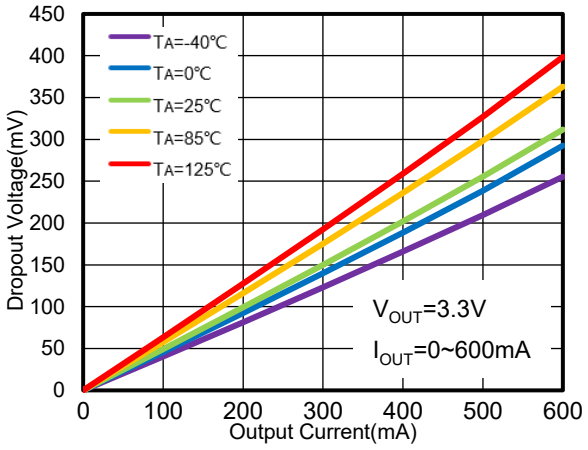


Figure 2. WR0612-ADFF6R
Dropout Voltage vs. I_{OUT} & Ambient Temperature

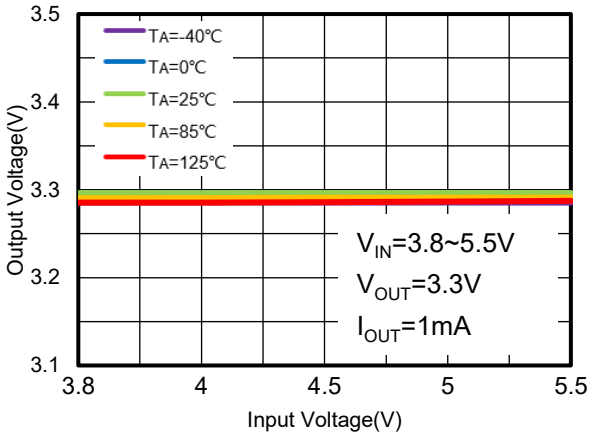


Figure 3. WR0612-ADFF6R
Output Voltage vs. V_{IN} & Ambient Temperature

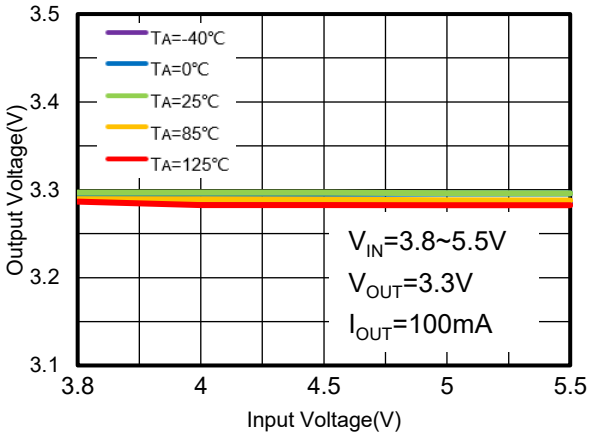


Figure 4. WR0612-ADFF6R
Output Voltage vs. V_{IN} & Ambient Temperature

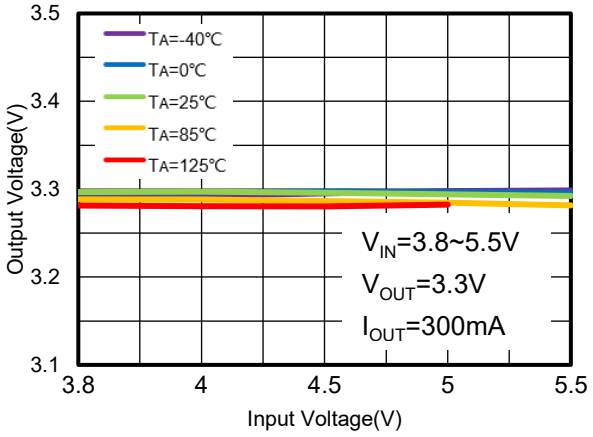


Figure 5. WR0612-ADFF6R
Output Voltage vs. V_{IN} & Ambient Temperature

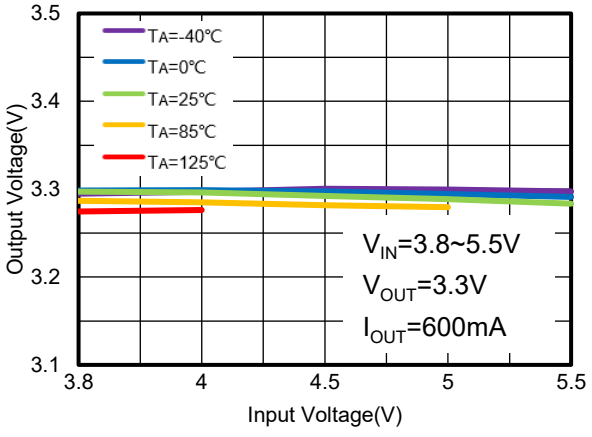


Figure 6. WR0612-ADFF6R
Output Voltage vs. V_{IN} & Ambient Temperature

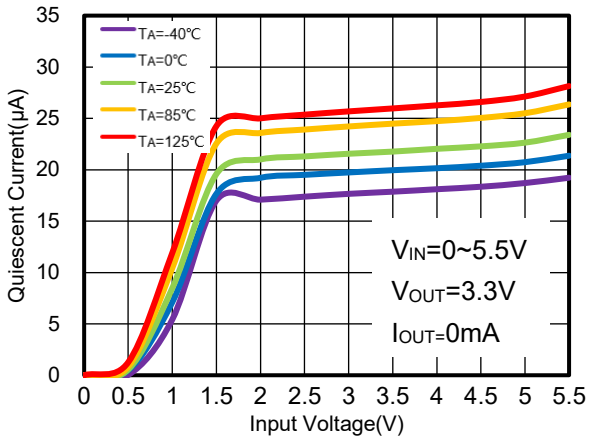


Figure 7. WR0612-ADFF6R
Quiescent Current vs. V_{IN} & Ambient Temperature

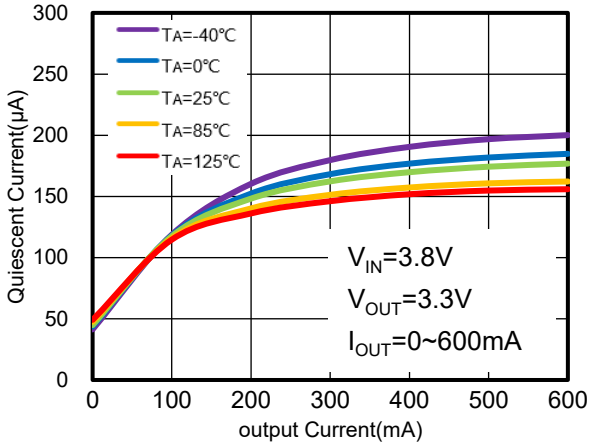


Figure 8. WR0612-ADFF6R
Quiescent Current vs. V_{IN} & Ambient Temperature

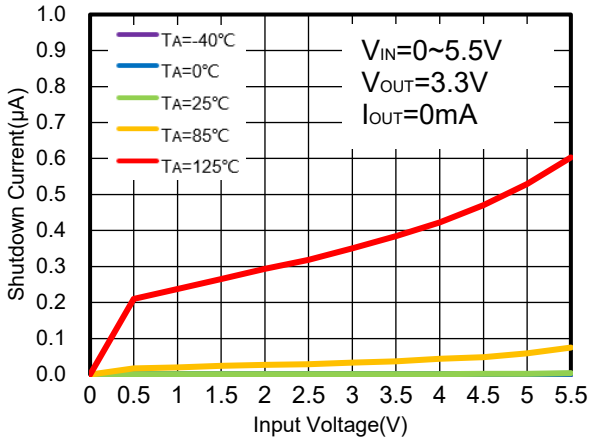


Figure 9. WR0612-ADFF6R
Shutdown Current vs. V_{IN} & Ambient Temperature

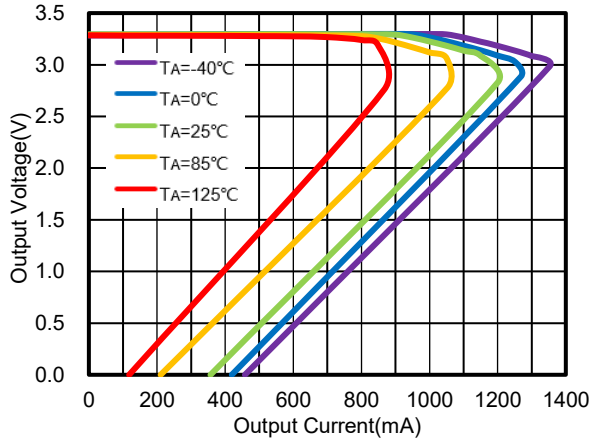


Figure 10. WR0612-ADFF6R
Current Limit vs I_{OUT} & Ambient Temperature

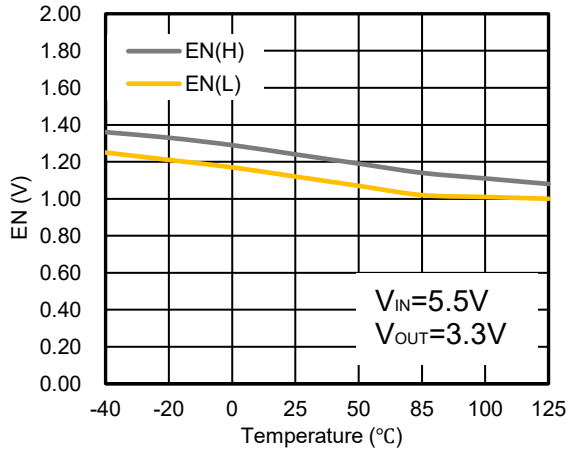


Figure 11. WR0612-ADFF6R
Enable Threshold vs. Ambient Temperature

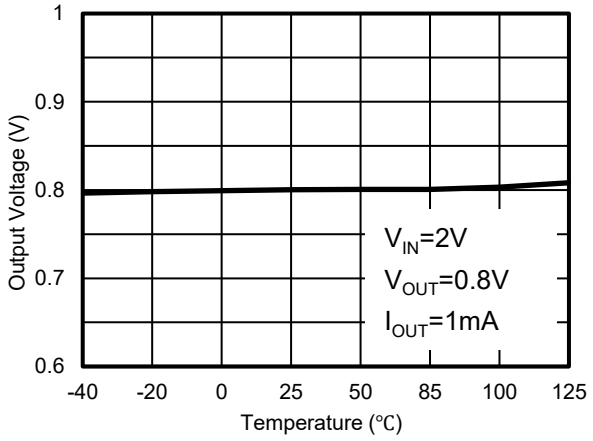


Figure 12. WR0612-ADFF6R
Output Voltage vs. Ambient Temperature

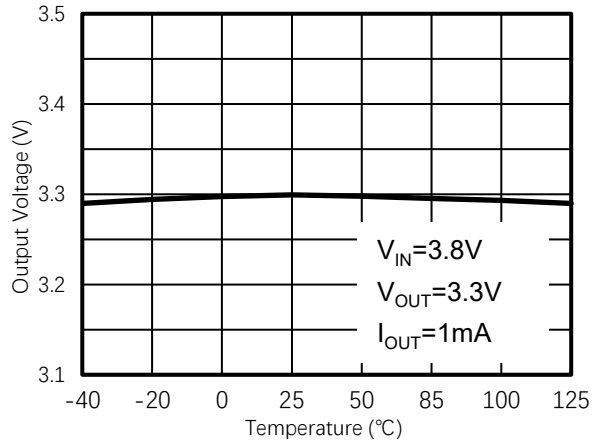


Figure 13. WR0612-ADFF6R
Output Voltage vs. Ambient Temperature

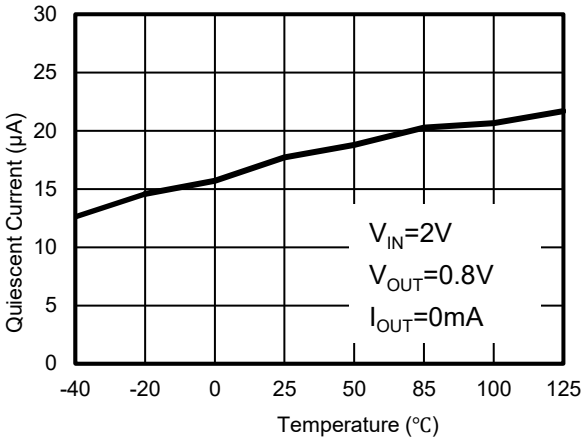


Figure 14. WR0612-ADFF6R
Quiescent Current vs. Ambient Temperature

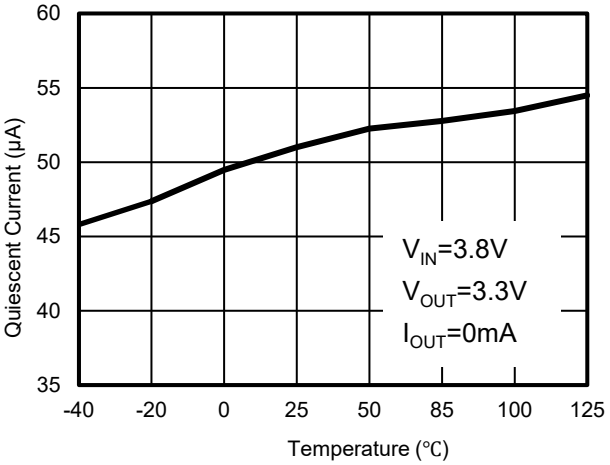


Figure 15. WR0612-ADFF6R
Quiescent Current vs. Ambient Temperature

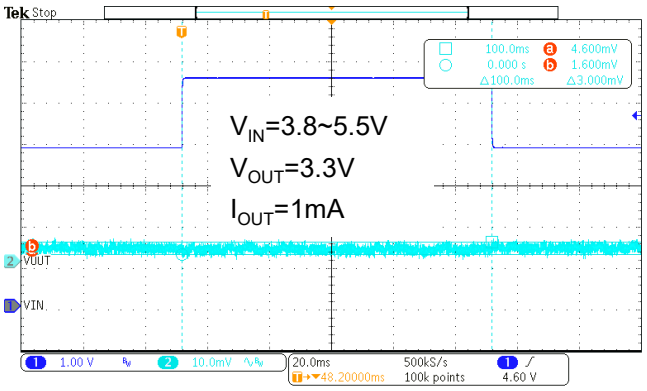


Figure 16. WR0612-ADFF6R
Line Transient

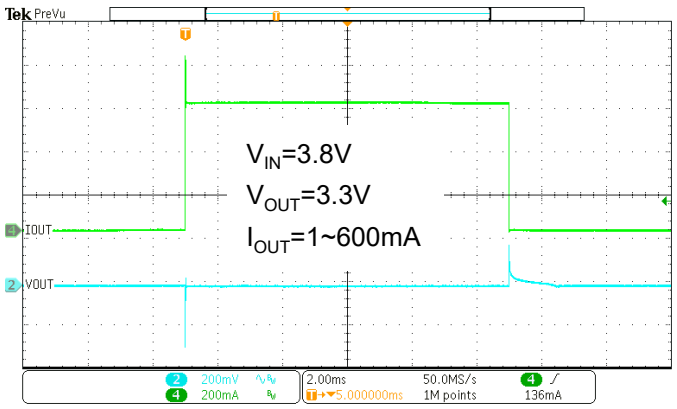


Figure 17. WR0612-ADFF6R
Load Transient

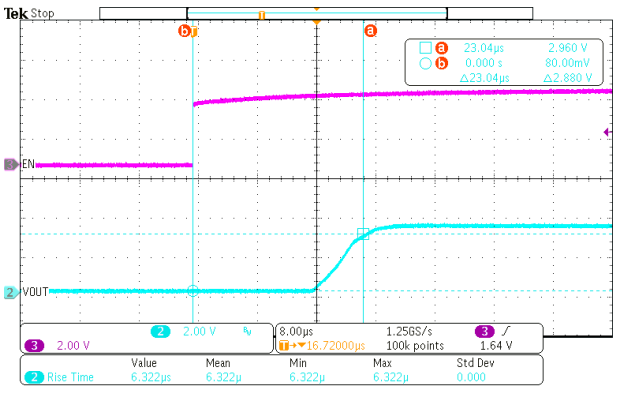


Figure 18. WR0612-ADFF6R
Soft Start from EN

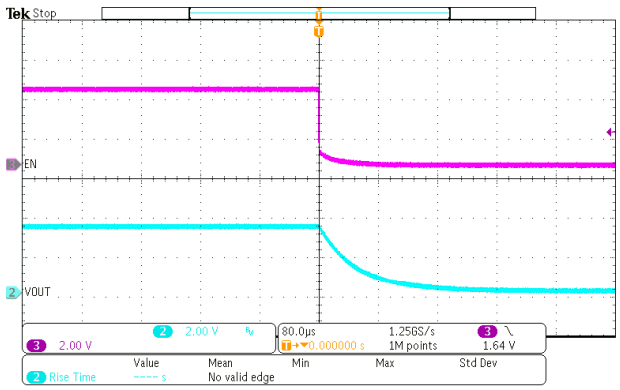


Figure 19. WR0612-ADFF6R
EN Shutdown

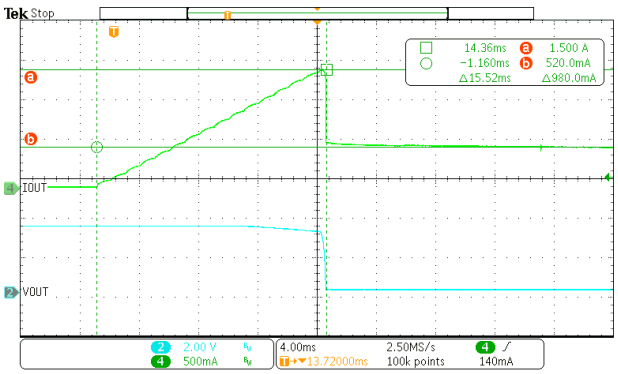


Figure 20. WR0612-ADFF6R
Current Limit

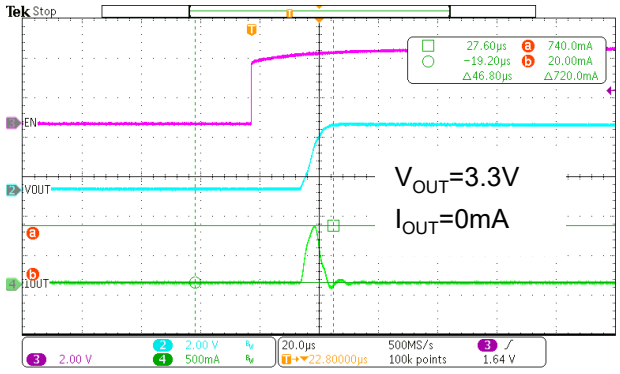


Figure 21. WR0612-ADFF6R
Inrush Current

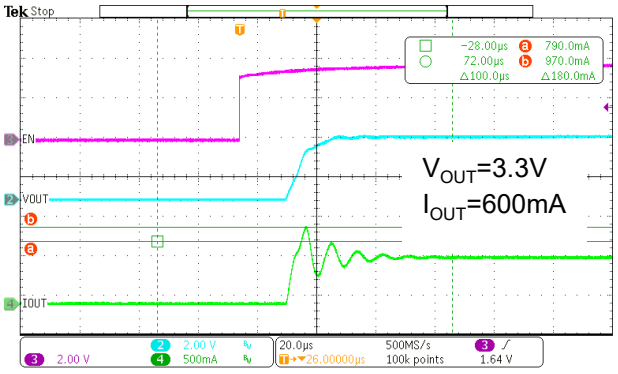


Figure 22. WR0612-ADFF6R
Inrush Current

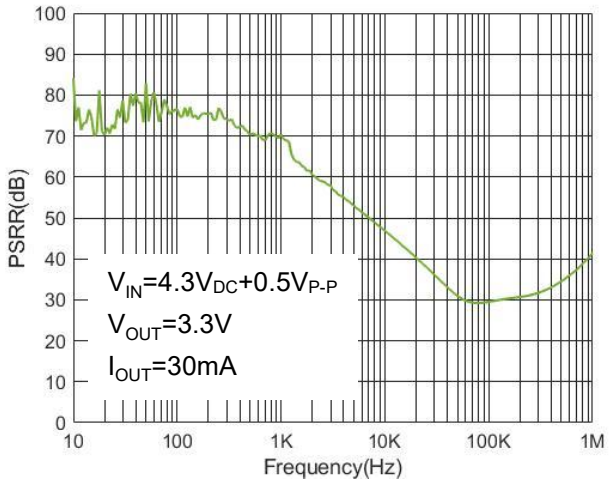


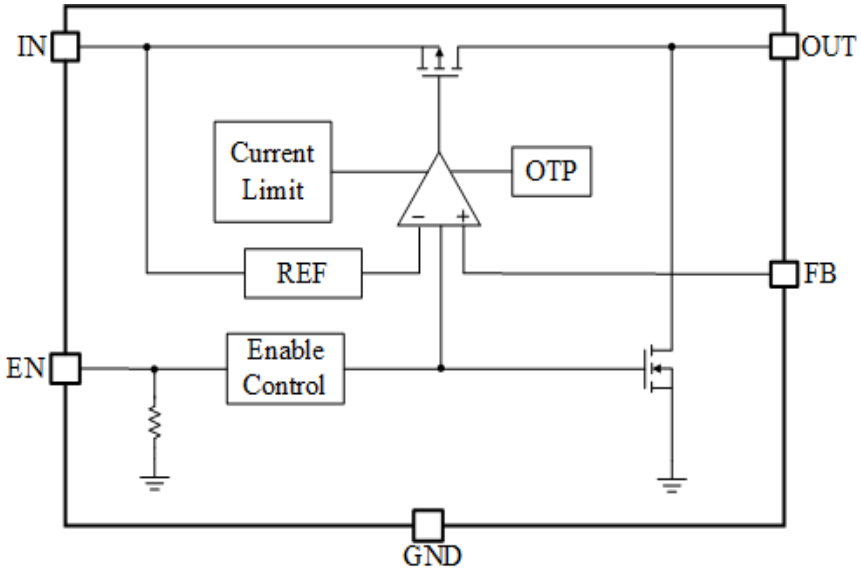
Figure 23. WR0612-ADFF6R
Power Supply Rejection Ratio vs. Frequency

11. Function Description

11.1 Overview

The WR0612 is high PSRR regulator capable of supplying 600mA and providing wide output voltage range. The device also offers low quiescent current, low-dropout voltage and very small packages suitable for space constrains application. The WR0612 is designed to be used in a variety of applications.

11.2 Block Diagram



11.3 Feature Description

11.3.1 Output Voltage Accuracy

The WR0612 has an output voltage accuracy of 2%. Output voltage accuracy is defined as the maximum and minimum error in output voltage. This includes the errors introduced by internal reference, load regulation and line regulation differences over the full range of rated load and line operating conditions, taking into account differences between manufacturing lots.

11.3.2 Enable (EN)

The WR0612 uses the EN pin to enable/disable its device and to activate /deactivate the active discharge function at devices with this feature. If the EN pin voltage is pulled below 0.4V the device is guaranteed to be disable. When EN is disabled, the active discharge transistor is activated and the output voltage V_{OUT} is pulled to GND through an internal circuitry with effective resistance about 50Ω.

If the voltage of EN pin is higher than 1.5V, the device is guaranteed to be enabled. In case the Enable function is not required, the EN pin should be connected directly to V_{IN}.

When EN pin floats, the device is disabled due to internal pull-down resistance of 6.8MΩ.

11.3.3 Dropout Voltage (V_{DO})

The WR0612 is an ultra-low dropout voltage LDO that can achieve nominal output voltage at lower input voltages. Dropout voltage is defined as the minimum of (V_{IN}-V_{OUT}) at the rated maximum output current where V_{OUT} is the minimum of $V_{OUT(NOM)}$. When the input voltage is below $V_{OUT(NOM)}$ plus V_{DO}, the output voltage varies with the input voltage.

For a CMOS regulator, the dropout voltage is determined by the drain-source on-state resistance ($R_{DS\ (ON)}$) of the pass transistor. Therefore, if the linear regulator operates at less than the rated current, the dropout voltage for that current scales accordingly. The $R_{DS\ (ON)}$ is calculated by following equation.

$$\mathbf{R_{DS(ON)}=V_{DO}/I_{OUT}}$$

11.3.4 Power Supply Rejection Ratio (PSRR)

PSRR, which stands for Power Supply Rejection Ratio, represents the ratio of the two voltage gains obtained when the input and output power supplies are considered as two independent sources.

The basic calculation formula is

$$\mathbf{PSRR = 20lg(Ripple(in) / Ripple(out))}$$

The units are in decibels (dB) and the logarithmic ratio is used.

The above equation shows that the output signal is influenced by the power supply in general, in addition to the circuit itself. PSRR is a quantity used to describe how the output signal is affected by the power supply; the larger the PSRR, the less the output signal is affected by the power supply.

As the level of integration continues to increase, the magnitude of supply current required is also increasing. End users want to extend battery life, i.e. they need very efficient DC/DC conversion processes, using more efficient switching regulators. However, switching regulators generate more ripple in the power line than linear regulators.

The PSRR shows the ability of the LDO to suppress input voltage noise. For a clean, noise-free DC output voltage, use an LDO with a high PSRR.

Noise coupling from the input voltage to the internal reference voltage is the main cause of PSRR performance degradation. Using noise reduction capacitors at the input can effectively filter out noise and improve PSRR performance at low frequencies. The LDO can be used not only to regulate the voltage but also to provide an exceptionally clean DC supply for noise sensitive components.

The WR0612 is a high PSRR LDO that can be used not only for voltage regulation but also for noise cancellation in the power supply.

11.3.5 Noise

LDO noise can be divided into two main categories: internal noise and external noise. Internal noise is the noise generated inside the electronics; external noise is the noise transmitted from outside the circuit to the circuit. The error amplifier determines the PSRR of the LDO and therefore its ability to suppress external noise at the input; internal noise is always present at the output of the LDO.

In practice, minimizing noise from the power supply is critical to system performance. In test and measurement systems, small fluctuations in power supply noise can alter the instantaneous measurement accuracy.

The WR0612 has a low noise reference, high PSRR to ensure that output noise is reduced during normal operation.

11.3.6 Fold-back Current Limit (I_{LIM})

In LDO circuits, if an output short circuit or excessive load current occurs, the device may be burned out. Especially in the case of a short circuit, not only is there too much current flowing through the regulator, but the voltage across the source drain of the regulator is also at its maximum, which is likely to burn out the regulator and make the device inoperable. The current limiting circuit used in LDO is a constant current limiting circuit, where the maximum load current that the LDO can supply is limited to a set constant I_{LIM}, and when an overload or short circuit occurs, the output current will be maintained at I_{LIM}, and the output voltage will be reduced to $I_{LIM}R_{LOAD}$.

However, if the external overload or short circuit condition lasts for a long time, the continuous high current will increase the device temperature and increase the power consumption of the whole system. To improve this situation, a fold-back current limiting circuit can be used. In a fold-back current limiting circuit, both the output current and the output voltage are gradually reduced when the output current reaches the set maximum current I_{LIM}. The output current is reduced to the set current threshold I_{SHORT} and the output voltage is reduced to $I_{SHORT}R_{LOAD}$. The output current is clamped to a smaller value in the event of an overload or short circuit and the system power consumption is reduced and the device temperature does not rise significantly.

The fold-back current limiting circuit is essentially a constant current limiting circuit with an output voltage feedback loop, so that in the event of an overload or short circuit, the output current is gradually reduced due to the reduction in output voltage and eventually clamped at a smaller value.

The WR0612 uses a fold-back current limiting mode where the final current is clamped to around 400mA, thus providing good protection to the device.

11.3.7 Thermal Protection

The WR0612 contains a thermal shutdown protection circuit that implements the required switching gate circuit function through a thermal switch integrated inside the chip. The output current is turned off when the heat in the LDO is too high. Thermal shutdown occurs when the thermal junction temperature (T_J) of the energized crystal exceeds 165°C (typical). The thermal shutdown hysteresis ensures that the LDO resets (turns on) again when the temperature drops to 145°C (typical). The thermal time constant of the semiconductor chip is quite short, so when thermal shutdown is reached, the output turns on and off at a higher rate until the power dissipation is reduced.

The WR0612's internal protection circuitry is designed to prevent thermal overload conditions. This circuitry is not a substitute for a proper heat sink. Continuously putting the WR0612 into a thermal shutdown state will reduce the reliability of the device.

11.4 Functional Modes of The Device

The device has three modes: normal, dropout, and disabled modes of operation.

The operating conditions of each mode are listed in the table below.

Operating conditions of each mode

FUNCTIONAL MODE	CONDITIONS			
	V_{IN}	V_{EN}	I_{OUT}	T_J
Normal	$5.5V>V_{IN} > V_{OUT(NOM)} + V_{DO}$	$V_{EN} > V_{ENH}$	$I_{OUT} < I_{LIM}$	$T_J < T_{SD}$
Dropout	$V_{IN} < V_{OUT(NOM)} + V_{DO}$	$V_{EN} > V_{ENH}$	$I_{OUT} < I_{LIM}$	$T_J < T_{SD}$
Disabled	—	$V_{EN} < V_{ENL}$	—	$T_J > T_{SD}$

11.4.1 Normal Mode

Normal operating mode requires that both of the following conditions are met.

1. The input voltage is greater than the rated output voltage plus the differential voltage ($V_{OUT(NOM)} + V_{DO}$) and is less than 5.5V.
2. The enable voltage has previously exceeded the enable rise threshold voltage and has not fallen below the enable fall threshold.
3. The output current is less than the current limit ($I_{OUT} < I_{LIM}$).
4. The device junction temperature is less than the thermal shutdown temperature ($T_J < T_{SD}$).

11.4.2 Dropout Mode

If the input voltage is below the rated output voltage plus a specified dropout voltage, the device operates in the dropout state and the output voltage tracks the input voltage.

11.4.3 Disabled

The WR0612 can be turned off by forcing the enable pin low, typically with an enable voltage below 0.4V, at which point the pass device is turned off, internal circuits are shutdown, and the output voltage is actively discharged to ground through an internal resistor from output to ground.

12. Application Guide

Note: The information in the Applications section below is not part of WAY-ON's product specifications and WAY-ON does not guarantee its accuracy or completeness. The customer is responsible for determining the suitability of the component for its intended use and should verify and test its design implementation to confirm system functionality.

12.1 Application Information

The WR0612 is a linear voltage regulator with an input voltage of 2.0V to 5.5V and an output voltage of 0.8V to 5.0V. The accuracy is 2% for output voltage. The maximum output current is 600mA. The efficiency of a linear voltage regulator is determined by the ratio of the output voltage to the input voltage, so in order to achieve high efficiency, the differential voltage (V_{IN} - V_{OUT}) must be as small as possible. This section discusses

how best to use this device in practical applications.

12.1.1 Capacitor Recommendation

The WR0612 uses ceramic capacitors with low equivalent series resistance (ESR) at the V_{IN} and V_{OUT} pins to increase its stability. Multilayer ceramic capacitors are recommended. These capacitors also have limitations, and ceramic capacitors with X7R-, X5R-, and COG-rated dielectric materials have relatively good capacitance stability at different temperatures. WR0612 is designed to use ceramic capacitors of 1μF at the input and output. Place C_{IN} and C_{OUT} as close to the IN and OUT pins as possible to minimize trace inductance from the capacitor to the device.

12.1.2 Power Dissipation (P_D)

The reliability of the circuit requires reasonable consideration of the power dissipation of the device, the location of the circuit on the PCB, and the proper sizing of the thermal plane. The regulator should be surrounded by no other heat generating devices as much as possible. The power dissipation of the regulator depends on the input and output voltage difference and the load conditions.

P_D can be calculated using the following equation:

$$P_D = (V_{IN} - V_{OUT}) \times I_{OUT}$$

Using the proper input voltage minimizes the power dissipation, resulting in greater efficiency. To obtain the lowest power dissipation, use the minimum input voltage required for normal output voltage.

The maximum power dissipation determines the maximum allowable ambient temperature (T_A) of the device. Power dissipation and junction temperature are typically related to the junction-ambient thermal resistance ($R_{\theta JA}$) and ambient air temperature (T_A) of the PCB and package and are calculated as follows

$$T_J = T_A + (R_{\theta JA} \times P_D)$$

The thermal resistance ($R_{\theta JA}$) depends primarily on the thermal dispersion capability of the PCB design. The total copper area, copper weight, and the location of the plane all affect the thermal dispersion capability, and the PCB and copper laydown area can only be used as a relative measure of the package's thermal performance.

13. Evaluation Modules

Evaluation Modules (EVMs) are available to help evaluate initial circuit performance. We have evaluation modules for different packages, you can contact us to get the evaluation modules or schematics, PCB layout and BOM.

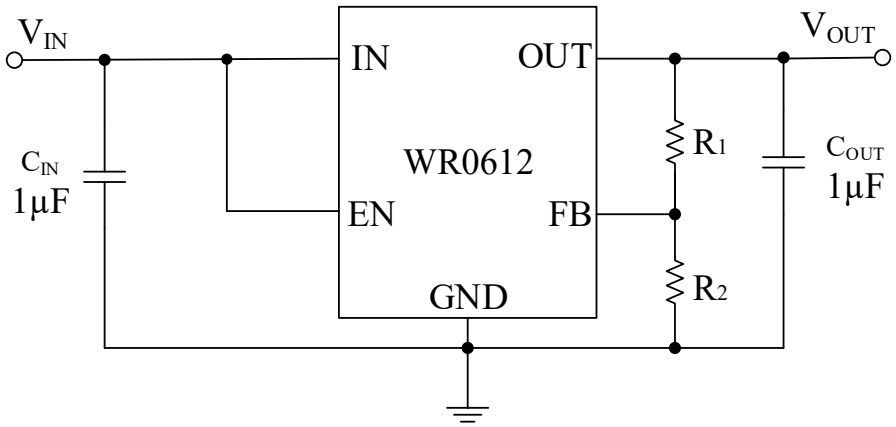
The module names are listed in the following table.

NAME	PACKAGE	EVALUATION MODULE
WR0612	DFN2×2-6	WAYON LDO EVM V1.1 - DFN2×2-6

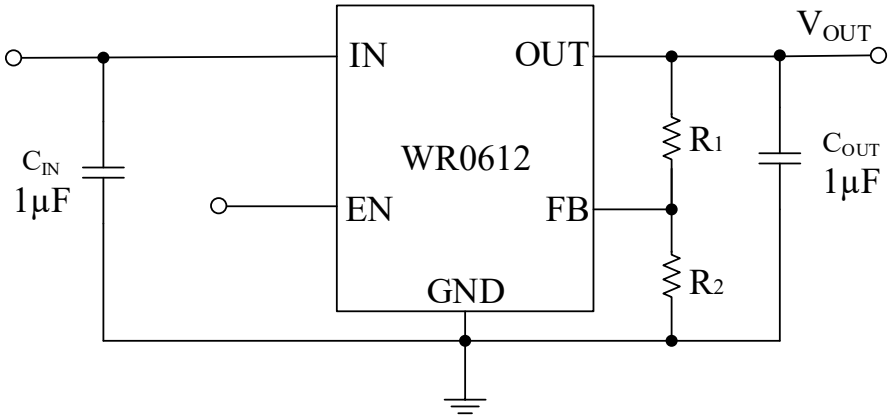
13.1 Schematic

This section discusses the application of the WR0612 in the circuit. The following figure shows the schematic of the application circuit.

Circuit schematic 1: EN is connected to IN.



Circuit schematic 2: EN is controlled by external voltage.



13.2 Layout

Layout Guidelines

The principle of LDO design is to place all components on the same side of the board and connect them as close as possible to their respective LDO pins. A 1.0μF input capacitor (C_{IN}) is recommended to IN to minimize the effect of resistance and inductance between the source and the LDO input. A 1.0μF or smaller output capacitor (C_{OUT}) is recommended to OUT. Connect the ground sides of C_{IN} and C_{OUT} with LDO ground pins as close as possible through a wide copper surface. Through-holes and long wires may seriously affect system performance and is not recommended.

To improve thermal performance, an array of thermal vias is used to connect the thermal pad to the ground plane. A larger ground plane improves the thermal performance of the device and reduces the operating temperature of the device.

14. Naming Conventions

WR AA BB-CC DDD E

WR: WAYON Regulator

AA: 06 - Output Current, 600mA

BB: Product Name

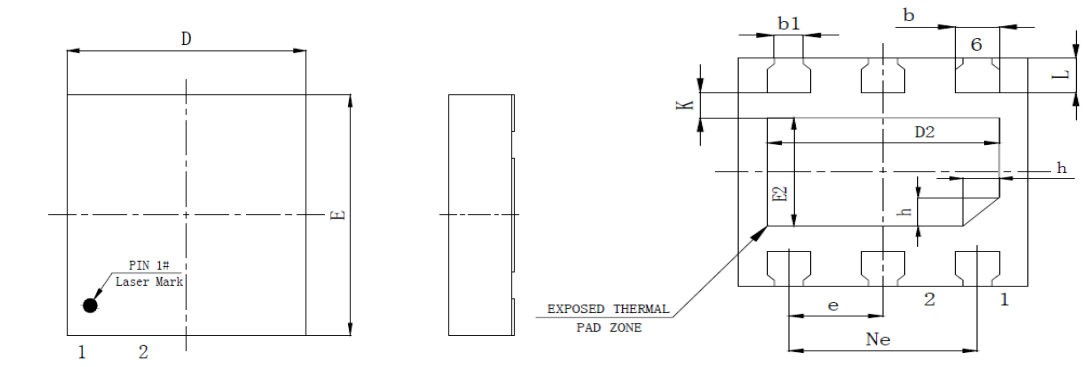
CC: Output Voltage

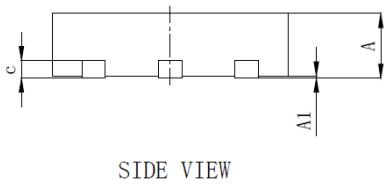
DDD: Package – FF6: DFN2×2-6

E: R-Reel

15. Package Information

DFN2×2-6L





SYMBOL	DIMENSIONS IN MILLIMETERS		
	MIN	NOM	MAX
A	0.70	0.75	0.80
A1	0	0.02	0.05
b	0.25	0.30	0.35
b1	0.15	0.20	0.25
c	0.10	0.15	0.20
D	1.90	2.00	2.10
D2	1.50	1.60	1.70
e	0.650BSC		
Ne	1.30BSC		
E	1.90	2.00	2.10
E2	0.85	0.95	1.05
L	0.25	0.30	0.35
h	0.20	0.25	0.30
K	0.20	0.225	0.28

16. Ordering Information

PART NUMBER	CURRENT LIMIT	PACKAGE	PACKING QUANTITY	MARKING*
WR0612-ADFF6R	ADJ	DFN2×2-6	3k/Reel	0612 XXXX

* XXXX is variable.

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Specifications are subject to change without notice.
The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.
Users should verify actual device performance in their specific applications

Product Specification Statement

- The product specification aims to provide users with a reference regarding various product parameters, performance, and usage. It presents certain aspects of the product's performance in graphical form and is intended solely for users to select product and make product comparisons, enabling users to better understand and evaluate the characteristics and advantages of the product. It does not constitute any commitment, warranty, or guarantee.
- The product parameters described in the product specification are numerical values, characteristics, and functions obtained through actual testing or theoretical calculations of the product in an independent or ideal state. Due to the complexity of product applications and variations in test conditions and equipment, there may be slight fluctuations in parameter test values. WAYON shall not guarantee that the actual performance of the product when installed in the customer's system or equipment will be entirely consistent with the product specification, especially concerning dynamic parameters. It is recommended that users consult with professionals for product selection and system design. Users should also thoroughly validate and assess whether the actual parameters and performance when installed in their respective systems or equipment meet their requirements or expectations. Additionally, users should exercise caution in verifying product compatibility issues, and WAYON assumes no responsibility for the application of the product.
- WAYON strives to provide accurate and up-to-date information to the best of our ability. However, due to technical, human, or other reasons, WAYON cannot guarantee that the information provided in the product specification is entirely accurate and error-free. WAYON shall not be held responsible for any losses or damages resulting from the use or reliance on any information in these product specifications. WAYON reserves the right to revise or update the product specification and the products at any time without prior notice, and the user's continued use of the product specification is considered an acceptance of these revisions and updates. Prior to purchasing and using the product, users should verify the above information with WAYON to ensure that the product specification is the most current, effective, and complete. If users are particularly concerned about product parameters, please consult WAYON in detail or request relevant product test reports. Any data not explicitly mentioned in the product specification shall be subject to separate agreement.
- Users are advised to pay attention to the parameter limit values specified in the product specification and maintain a certain margin in design or application to ensure that the product does not exceed the parameter limit values defined in the product specification. This precaution should be taken to avoid exceeding one or more of the limit values, which may result in permanent irreversible damage to the product, ultimately affecting the quality and reliability of the system or equipment.
- The design of the product is intended to meet civilian needs and is not guaranteed for use in harsh environments or precision equipment. It is not recommended for use in systems or equipment such as medical devices, aircraft, nuclear power, and similar systems, where failures in these systems or equipment could reasonably be expected to result in personal injury. WAYON shall assume no responsibility for any consequences resulting from such usage.
- Users should also comply with relevant laws, regulations, policies, and standards when using the product specification. Users are responsible for the risks and liabilities arising from the use of the product specification and must ensure that it is not used for illegal purposes. Additionally, users should respect the intellectual property rights related to the product specification and refrain from infringing upon any third-party legal rights. WAYON shall assume no responsibility for any disputes or controversies arising from the above-mentioned issues in any form.